The ABLIC S-UM6532 is a low charge injection 64-channel single-pole single-throw (SPST) high-voltage analog switch IC operated only by a single 5 V for ultrasound imaging applications. The S-UM6532 has $\pm 100 \mathrm{~V}$ analog signal range allowing $\pm 150 \mathrm{~V}$ voltage overshoot.

## $\square$ Function

- 64-channel high-voltage SPST analog switches with user-selectable logic interface and bleed resistor


## - Features

- 0 V to $\pm 100 \mathrm{~V}$ analog signal voltage range allowing $\pm 150 \mathrm{~V}$ voltage overshoot
- 10 kHz to 70 MHz analog signal frequency range
- 2A peak analog signal current per channel
- $6 \Omega$ switch on-resistance
- Single +5 V power supply (NO HIGH-VOLTAGE POWER SUPPLY required)
- User-selectable Serial Digital Interface (64-bit shift registers) or Bank Interface (4 banks of 16-channel)
- User-selectable $40 \mathrm{k} \Omega$ bleed resistor on probe side
- Low on/off-capacitance
- 15 pC charge injection to 1000 pF
- -75dB off-isolation at analog small-signal 5 MHz
- -60dB switch crosstalk
- 1.8 V to 5 V CMOS logic interface
- Low power dissipation (static 5 mW )
- Embedded thermal protection with flag indicator
- RoHS compliant $15 \times 15 \mathrm{~mm}$ BGA package


## LOW CHARGE INJECTION 64-CHANNEL $6 \Omega$ HIGH-VOLTAGE ANALOG SWITCHES S-UM6532

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Absolute Maximum Ratings
$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| No. | Items | Symbol | Value | Units | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Positive logic supply voltage | $\mathrm{V}_{\mathrm{LL}}$ | -0.4 to +7 | V |  |
| 2 | Positive supply voltage | $V_{\text {DD }}$ | -0.4 to +7 | V |  |
| 3 | Logic input voltage | DIN, CLKIN, RESET, CLR, LEB, BANK0, BANK1, BANK2, BANK3, BANK_EN, CLKOUT_EN, R_ENB | -0.4 to +7 | V |  |
| 4 | Logic output voltage | DOUT, CLKOUT, THP | -0.4 to +7 | V |  |
| 5 | Analog signal range (steady state voltage) | $\mathrm{V}_{\text {SIG }}$ | -105 to +105 | V |  |
| 6 | Analog signal range (peak overshoot voltage) | $\mathrm{V}_{\text {SIG_Os }}$ | -150 to +150 | V | Max. 500ns pulse width |
| 7 | Peak analog signal current per channel | $\mathrm{I}_{\text {sw }}$ | 2 | A |  |
| 8 | Operating junction temperature | $\mathrm{T}_{\text {Jop }}$ | -20 to +150 | ${ }^{\circ} \mathrm{C}$ |  |
| 9 | Storage temperature | $\mathrm{T}_{\text {STG }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |  |
| 10 | Maximum power dissipation | $\mathrm{P}_{\text {Dmax }}$ | 4 | W |  |

## Operating Supply Voltages, Temperature, Logic Levels

| No. | Items | Symbol | Min | Typ | Max | Units | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Logic supply voltage | $\mathrm{V}_{\mathrm{LL}}$ | 1.7 | 1.8 to 5 | $V_{D D}$ | V |  |
| 2 | Positive supply voltage | $V_{D D}$ | 4.75 | 5 | 5.25 | V |  |
| 3 | Operating free-air temperature | $\mathrm{T}_{\mathrm{A}}$ | 0 | - | 75 | ${ }^{\circ} \mathrm{C}$ |  |
| 4 | High-level logic input voltage | $\mathrm{V}_{\mathrm{IH}}$ | $0.8 \mathrm{~V}_{\mathrm{LL}}$ | - | $\mathrm{V}_{\mathrm{LL}}$ | V |  |
| 5 | Low-level logic input voltage | $\mathrm{V}_{\text {IL }}$ | 0 | - | $0.2 \mathrm{~V}_{\mathrm{LL}}$ | V |  |
| 6 | High-level logic output voltage | $\mathrm{V}_{\mathrm{OH}}$ | $0.8 \mathrm{~V}_{\mathrm{LL}}$ | - | - | V | $\mathrm{I}_{\text {SOURCE }}=1 \mathrm{~mA}$ |
| 7 | Low-level logic output voltage | $\mathrm{V}_{\mathrm{OL}}$ | - | - | $0.2 \mathrm{~V}_{\mathrm{LL}}$ | V | $\mathrm{I}_{\text {SINK }}=1 \mathrm{~mA}$ |
| 8 | Logic input high current *1) | $\mathrm{I}_{\mathrm{H}}$ | -10 | - | 10 | $\mu \mathrm{A}$ | DIN, CLKIN, RESET, CLR, LEB, BANKO, BANK1, BANK2, BANK3, BANK_EN, CLKOUT_EN, R_ENB |
| 9 | Logic input low current | $1 / 1$ | -10 | - | 10 | $\mu \mathrm{A}$ |  |
| 10 | Logic input capacitance | $\mathrm{C}_{\text {IN }}$ | - | 2 | - | pF |  |
| 11 | Clock frequency | $\mathrm{f}_{\text {CLK }}$ | - | - | 50 | MHz | CLKOUT_EN=0, $\mathrm{V}_{\mathrm{LL}}=1.8 \mathrm{~V}$ |
|  |  |  | - | - | 80 | MHz | CLKOUT_EN=0, $\mathrm{V}_{\mathrm{LL}}=2.5 \mathrm{~V}$ |
|  |  |  | - | - | 95 | MHz | CLKOUT_EN=0, $\mathrm{V}_{\mathrm{LL}}=3.3 \mathrm{~V}$ |
|  |  |  | - | - | 60 | MHz | CLKOUT_EN=1, $\mathrm{V}_{\mathrm{LL}}=1.8 \mathrm{~V}$ |
|  |  |  | - | - | 85 | MHz | CLKOUT_EN=1, $\mathrm{V}_{\mathrm{LL}}=2.5 \mathrm{~V}$ |
|  |  |  | - | - | 130 | MHz | CLKOUT_EN=1, $\mathrm{V}_{\text {LL }}=3.3 \mathrm{~V}$ |
| 12 | Clock rise and fall times | $\mathrm{t}_{\mathrm{R},} \mathrm{t}_{\mathrm{F}}$ | - | - | 50 | ns |  |
| 13 | CLKIN to DOUT delay | $\mathrm{t}_{\mathrm{DO}}$ | 7 | 10 | 24 | ns |  |
| 14 | CLKOUT to DOUT delay | $\mathrm{t}_{\mathrm{DO} 1}$ | 1.3 | - | 1.9 | ns |  |
| 15 | CLKIN to CLKOUT delay | $\mathrm{t}_{\text {DCKO }}$ | 7 | 10 | 24 | ns |  |
| 16 | DIN to CLKIN setup time | $\mathrm{t}_{\text {Su }}$ | 1 | - | - | ns |  |
| 17 | DIN to CLKIN hold time | $\mathrm{t}_{\mathrm{HD}}$ | 2 | - | - | ns |  |
| 18 | LEB setup time | $\mathrm{t}_{\text {SLEB }}$ | 5 | - | - | ns |  |
| 19 | LEB low-pulse width | $\mathrm{t}_{\text {WLEB }}$ | 12 | - | - | ns |  |
| 20 | CLR response time | $\mathrm{t}_{\text {DCLR }}$ | - | - | 500 | ns |  |
| 21 | CLR high-pulse width | $\mathrm{t}_{\text {WCLR }}$ | 12 | - | - | ns |  |
| 22 | Bank interface setup time | $\mathrm{t}_{\text {SBNK }}$ | 100 | - | - | ns |  |
| 23 | Bank interface hold time | $\mathrm{t}_{\text {HBNK }}$ | 1 | - | - | us |  |
| 24 | BANKx minimum pulse width | $\mathrm{t}_{\text {WBNK }}$ | 4 | - | - | us |  |
| 25 | RESET response time | $\mathrm{t}_{\text {DRST }}$ | - | - | 400 | ns |  |
| 26 | RESET high-pulse width | $\mathrm{t}_{\text {WRST }}$ | 12 | - | - | ns |  |

NOTE: *1) BANK_EN, CLKOUT_EN, and R_ENB have $100 \mu \mathrm{~A}$ leakage at $\mathrm{V}_{\mathrm{LL}}=5 \mathrm{~V}$ due to $50 \mathrm{k} \Omega$ internal pull-down resistor.

## Power Supply Sequencing

No power supply sequencing is required even if $\mathrm{V}_{\mathrm{LL}}$ is different from $\mathrm{V}_{\mathrm{DD}}$. Please apply the $\mathrm{V}_{\mathrm{DD}}$ voltage to the $\mathrm{V}_{\mathrm{LL}}$ when operating with a single 5 V .

## ■ DC Characteristics

$\mathrm{V}_{\mathrm{LL}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{LEB}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.

| No. | Items | Symbol | Spec |  |  | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
| 1 | Analog signal range (steady state voltage) | $\mathrm{V}_{\text {SIG }}$ | -100 | - | +100 | V |  |
| 2 | Analog signal range (peak overshoot voltage) | $\mathrm{V}_{\text {SIG_Os }}$ | -150 | - | +150 | V | Max. 500ns pulse width |
| 3 | $\mathrm{V}_{\mathrm{LL}}$ quiescent current | ILLQ | - | 0.2 | - | $\mu \mathrm{A}$ | Quiescent current-1 All switches off |
| 4 | $\mathrm{V}_{\mathrm{DD}}$ quiescent current | $\mathrm{I}_{\text {DDQ }}$ | - | 4.3 | - | mA |  |
| 5 | $\mathrm{V}_{\mathrm{LL}}$ quiescent current | ILLQ | - | 0.2 | - | $\mu \mathrm{A}$ | Quiescent current-2 All switches on |
| 6 | $\mathrm{V}_{\mathrm{DD}}$ quiescent current | $\mathrm{I}_{\text {DDQ }}$ | - | 4.3 | - | mA |  |
| 7 | $\mathrm{V}_{\text {LL }}$ dynamic current | $\mathrm{ILL}^{\text {L }}$ | - | 2 | 10 | $\mu \mathrm{A}$ | Dynamic current <br> All channels switching simultaneously at $\mathrm{f}_{\mathrm{sw}}=50 \mathrm{kHz}$ |
| 8 | $V_{D D}$ dynamic current | $\mathrm{I}_{\mathrm{DD}}$ | - | 9 | 11 | mA |  |
| 9 | DC offset switch off | $\mathrm{V}_{\text {OS }}$ | - | 0 | - | mV |  |
| 10 | Small signal switch on-resistance | $\mathrm{R}_{\text {ONS }}$ | - | 6 | 8 | $\Omega$ | $\mathrm{V}_{\text {SIG }}=0.1 \mathrm{Vpp}$ to 5 Vpp @ $5 \mathrm{MHz}, \mathrm{R}_{\mathrm{s}}=10 \Omega$ |
| 11 | Small signal switch on-resistance matching | $\Delta \mathrm{R}_{\mathrm{ONS}}$ | - | 2 | 5 | \% | $\mathrm{V}_{\text {SIG }}=0 \mathrm{~V}, \mathrm{I}_{\text {SIG }}=5 \mathrm{~mA}$ |
| 12 | Large signal switch on-resistance | $\mathrm{R}_{\text {ONL }}$ | - | 6 | - | $\Omega$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SIG}}=20 \mathrm{Vpp} @ 5 \mathrm{MHz}, \\ & \mathrm{R}_{\mathrm{S}}=10 \Omega \end{aligned}$ |
| 13 | Bleed resistance | $\mathrm{R}_{\text {BLD }}$ | 30 | 40 | 50 | k $\Omega$ | R_ENB=0, probe side only |
| 14 | Switch output peak current | $\mathrm{I}_{\text {sw }}$ | - | 2 | - | A | 100ns pulse, $0.1 \%$ duty cycle |

## Thermal Protection Characteristics

$V_{L L}=3.3 V, V_{D D}=5 \mathrm{~V}, \mathrm{LEB}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.

| No. | Items |  | Symbol | Spec |  |  | Units |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: | :--- |
|  |  |  |  |  |  |  |  |
|  |  |  | Min | Typ | Max |  |  |
| 1 | THP pull-up voltage | $\mathrm{V}_{\text {PUTHP }}$ | - | - | 5.25 | V | Open drain |
| 2 | THP output current | $\mathrm{I}_{\text {THP }}$ | - | 1.0 | - | mA | - |
| 3 | THP output low voltage | $\mathrm{V}_{\text {OLTHP }}$ | - | - | 0.5 | V | THP active, $\mathrm{V}_{\mathrm{LL}}=3.3 \mathrm{~V}, \mathrm{I}_{\text {THP }}=1 \mathrm{~mA}$ |
| 4 | THP temperature threshold | $\mathrm{T}_{\text {THP }}$ | 90 | 110 | 130 | ${ }^{\circ} \mathrm{C}$ | Thermal protection flag indicator by THP pin <br> (open N-MOS drain, Low $=\mathrm{THP}$ activating) |
| 5 | THP reset hysteresis | $\mathrm{T}_{\text {HYSTHP }}$ | - | 10 | - | ${ }^{\circ} \mathrm{C}$ |  |

## ■ AC Characteristics

$V_{L L}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{LEB}=0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.

| No. | Items |  | Symbol | Spec |  |  | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
| 1 | Turn-on time |  |  | $\mathrm{t}_{\mathrm{ON}}$ | - | 2 | 4 | $\mu \mathrm{s}$ | BANK_EN=0 |
|  |  |  | $\mathrm{t}_{\text {ON_BNK }}$ | - | 2 | 4 | $\mu \mathrm{s}$ | BANK_EN=1 |
| 2 | Turn-off time |  | $\mathrm{t}_{\text {OFF }}$ | - | 2 | 4 | $\mu \mathrm{s}$ | BANK_EN=0 |
|  |  |  | $\mathrm{t}_{\text {OFF_BNK }}$ | - | 2 | 4 | $\mu \mathrm{s}$ | BANK_EN=1 |
| 3 | Output switching frequency |  | $\mathrm{f}_{\text {Sw }}$ | - | - | 50 | kHz | Duty cycle=50\% |
| 4 | Small signal frequency |  | $\mathrm{f}_{\text {SIG }}$ | 0.01 | - | 70 | MHz | $\mathrm{C}_{\mathrm{L}}=220 \mathrm{pF}$ |
| 5 | Off isolation | small signal | $\mathrm{V}_{\text {ISO(RX) }}$ | - | -75 | - | dB | $\mathrm{f}_{\text {SIG }}=5 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ |
|  |  | large signal | $\mathrm{V}_{\text {ISO(TX) }}$ | - | -60 | - | dB | $\mathrm{f}_{\text {SIG }}=5 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ |
| 6 | Crosstalk |  | $\mathrm{V}_{\text {CT }}$ | - | -60 | - | dB | $\mathrm{f}_{\mathrm{SIG}}=5 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ |
| 7 | On capacitance | small signal | $\mathrm{C}_{\text {ON(RX) }}$ | - | 27 | - | pF | $\mathrm{V}_{\text {SIG }}=0 \mathrm{~V}, \mathrm{f}_{\text {SIG }}=1 \mathrm{MHz}$ |
|  |  | large signal | $\mathrm{C}_{\text {ON(TX) }}$ | - | 27 | - | pF | $\mathrm{V}_{\text {SIG }}=10 \mathrm{Vpp}, \mathrm{f}_{\text {SIG }}=1 \mathrm{MHz}$ |
| 8 | Off capacitance SW_P to GND | small signal | $\mathrm{C}_{\text {OFF(SWP_RX) }}$ | - | 18 | - | pF | $\mathrm{V}_{\text {SIG }}=0 \mathrm{~V}, \mathrm{f}_{\text {SIG }}=1 \mathrm{MHz}$ |
| 9 | Off capacitance SW_A to GND | small signal | $\mathrm{C}_{\text {OFF(SWA_RX) }}$ | - | 14 | - | pF | $\mathrm{V}_{\text {SIG }}=0 \mathrm{~V}, \mathrm{f}_{\text {SIG }}=1 \mathrm{MHz}$ |
|  |  | large signal | $\mathrm{C}_{\text {OFF(SWA_TX) }}$ | - | 16 | - | pF | $\mathrm{V}_{\text {SIG }}=10 \mathrm{Vpp}, \mathrm{f}_{\text {SIG }}=1 \mathrm{MHz}$ |
| 10 | Output spike voltage (SW_P) |  | $\mathrm{V}_{\text {SPK_ON(SWP) }}$ | - | 30 | - | mV | $50 \Omega$ load @switch on |
|  |  |  | $\mathrm{V}_{\text {SPK_OFF(SWP) }}$ | - | 60 | - | mV | $50 \Omega$ load @switch off |
| 11 | Output spike voltage (SW_A) |  | $\mathrm{V}_{\text {SPK_ON(SWA) }}$ | - | 30 | - | mV | $50 \Omega$ load @switch on |
|  |  |  | $\mathrm{V}_{\text {SPK_OFF/(SWA) }}$ | - | 60 | - | mV | $50 \Omega$ load @switch off |
| 12 | Charge injection |  | QC | - | 15 | - | pC |  |



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Truth Table

| Logic Inputs |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  | Analog Switch State |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESET | LEB | CLR | BANK <br> _EN | BANKO | BANK1 | BANK2 | BANK3 | DIN |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  | D0 | $\cdots$ | D15 | D16 | $\cdots$ | D31 | D32 | $\cdots$ | D47 | D48 | $\cdots$ | D63 | swo | $\cdots{ }^{\cdot}$ SW15 | SW16 | . ${ }^{\text {a }}$ SW31 | SW32 | $\cdots$ | SW47 | SW48 | SW63 |
| L | L | L | L | x | x | X | X | L |  | - | - |  | - | - |  | - | - |  | - | OFF | - | - | - | - |  | - | - | - |
| L | L | L | L | X | x | X | X | H |  | - | - |  | - | - |  | - | - |  | - | ON | - | - | - | - |  | - | - | - |
| L | L | L | L | x | x | x | x | - |  | L | - |  | - | - |  | - | - |  | - | - | OFF | - | - | - |  | - | - | - |
| L | L | L | L | x | x | x | x | - |  | H | - |  | - | - |  | - | - |  | - | - | ON | - | - | - |  | - | - | - |
| L | L | L | L | x | x | x | x | - |  | - | L |  | - | - |  | - | - |  | - | - | - | OFF | - | - |  | - | - | - |
| L | L | L | L | X | x | X | X | - |  | - | H |  | - | - |  | - | - |  | - | - | - | ON | - | - |  | - | - | - |
| L | L | L | L | X | x | X | X | - |  | - | - |  | L | - |  | - | - |  | - | - | - | - | OFF | - |  | - | - | - |
| L | L | L | L | x | x | x | x | - |  | - | - |  | H | - |  | - | - |  | - | - | - | - | ON | - |  | - | - | - |
| L | L | L | L | x | x | X | x | - |  | - | - |  | - | L |  | - | - |  | - | - | - | - | - | OFF |  | - | - | - |
| L | L | L | L | X | x | X | X | - |  | - | - |  | - | H |  | - | - |  | - | - | - | - | - | ON |  | - | - | - |
| L | L | L | L | x | x | x | x | - |  | - | - |  | - | - |  | L | - |  | - | - | - | - | - | - |  | OFF | - | - |
| L | L | L | L | x | x | x | x | - |  | - | - |  | - | - |  | H | - |  | - | - | - | - | - | - |  | ON | - | - |
| L | L | L | L | X | x | X | X | - |  | - | - |  | - | - |  | - | L |  | - | - | - | - | - | - |  | - | OFF | - |
| L | L | L | L | x | x | x | x | - |  | - | - |  | - | - |  | - | H |  | - | - | - | - | - | - |  | - | ON | - |
| L | L | L | L | X | x | X | X | - |  | - | - |  | - | - |  | - | - |  | L | - | - | - | - | - |  | - | - | OFF |
| L | L | L | L | x | x | X | x | - |  | - | - |  | - | $\checkmark$ |  | - | - |  | H | - | - | - | - | - |  | - | - | ON |
| L | H | L | L | X | X | X | X | X | X | X | X | x | X | X | x | X | X | X | X |  |  |  | Hold Prev | ous Stat |  |  |  |  |
| L | X | H | L | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X | X |  |  |  | ALL SW | s OFF |  |  |  |  |
| H | H | L | L | X | X | X | X | L | L | L | L | L | L | L | L | L | L | L | L |  |  |  | Hold Prev | ous State |  |  |  |  |
| H | L | L | L | X | X | X | X | L | L | L | L | L | L | L | L | L | L | L | L |  |  |  | ALL SW | s OFF |  |  |  |  |
| X | X | X | H | H | L | L | L | X | X | X | X | X | X | X | X | X | X | X | X | swo | SW15 ON | SW16 | SW31 OFF | SW32 | SW4 | 7 OFF | SW48 | SW63 OFF |
| X | X | X | H | L | H | L | L | X | x | X | X | $\times$ | X | X | X | X | X | X | X | SW0 | SW15 OFF | SW16 | SW31 ON | SW32 | SW4 | 7 OFF | SW48 | SW63 OFF |
| X | X | X | H | L | L | H | L | X | X | X | X | X | X | X | X | X | X | X | X | SW0 | SW15 OFF | SW16 | SW31 OFF | SW32 | SW | 47 ON | SW48 | SW63 OFF |
| X | X | X | H | L | L | L | H | X | x | X | X | x | X | X | X | X | X | x | X | swo | SW15 OFF | SW16 | SW31 OFF | SW32 | SW4 | 7 OFF | SW48 | SW63 ON |



## Latch Enable Interface Timing



- Pin Description
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| Pin Name | I/O | Function |
| :---: | :---: | :--- |
| VLL | - | Positive voltage supply of low voltage interface (+1.8V~+5V) |
| VDD | - | Positive low voltage power supply (+5V) |
| GND | - | Drive power ground (0V) |
| RGND | - | Bleed resistor ground (0V) |
| DIN | I | Serial-Data input |
| DOUT | O | Serial-Data output |
| CLKIN | I | Serial-Clock input |
| CLKOUT | O | Serial-Clock output |
| LEB | I | Active-Low latch enable input, Hi=Hold data, Low=Latch data input |
| BANK0 | I | Bank-Data input 0 for SW0 to SW15, Hi=ON, Low=OFF |
| BANK1 | I | Bank-Data input 1 for SW16 to SW31, Hi=ON, Low=OFF |
| BANK2 | I | Bank-Data input 2 for SW32 to SW47, Hi=ON, Low=OFF |
| BANK3 | I | Bank-Data input 3 for SW48 to SW63, Hi=ON, Low=OFF |
| RESET | I | Shift register reset input |
| CLR | I | Latch clear input |
| CLKOUT_EN | I | Clock out enable input, Hi=Clock out, Low=Disable (Low) |
| R_ENB | I | Bleed resistor enable input, Hi=Disable, Low=Enable |
| BANK_EN | I | Bank interface enable input, Hi=Bank-Data interface, Low=Serial-Data interface |
| THP | O | Thermal protection output flag, open N-MOS drain (Low=THP activating) |
| SWx_A | I/O | Analog switch terminal n (AFE side), Suffix "x" corresponds to channel number (x=0 to 63) |
| SWx_P | I/O | Analog switch terminal n (Probe side), Suffix "x" corresponds to channel number (x=0 to 63) |
| NC | - | No connection (Not internally connected) |

Pin Configuration (Table)

| No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A1 | DIN | B1 | CLKIN | C1 | VLL | D1 | SW63_A | E1 | NC | F1 | SW61_A |
| A2 | LEB | B2 | RESET | C2 | VDD | D2 | NC | E2 | SW62_A | F2 | NC |
| A3 | GND | B3 | GND | C3 | RGND | D3 | SW63_P | E3 | NC | F3 | SW61_P |
| A4 | SW0_A | B4 | NC | C4 | SW0_P | D4 | NC | E4 | SW62_P | F4 | NC |
| A5 | NC | B5 | SW1_A | C5 | NC | D5 | SW1_P | E5 | NC | F5 | NC |
| A6 | SW2_A | B6 | NC | C6 | SW2_P | D6 | NC | E6 | NC | F6 | NC |
| A7 | NC | B7 | SW3_A | C7 | NC | D7 | SW3_P | E7 | NC | - | - |
| A8 | SW4_A | B8 | NC | C8 | SW4_P | D8 | NC | E8 | NC | - | - |
| A9 | NC | B9 | SW5_A | C9 | NC | D9 | SW5_P | E9 | NC | - | - |
| A10 | SW6_A | B10 | NC | C10 | SW6_P | D10 | NC | E10 | NC | - | - |
| A11 | NC | B11 | SW7_A | C11 | NC | D11 | SW7_P | E11 | NC | - | - |
| A12 | SW8_A | B12 | NC | C12 | SW8_P | D12 | NC | E12 | NC | - | - |
| A13 | NC | B13 | SW9_A | C13 | NC | D13 | SW9_P | E13 | NC | - | - |
| A14 | SW10_A | B14 | NC | C14 | SW10_P | D14 | NC | E14 | NC | -- | - |
| A15 | NC | B15 | SW11_A | C15 | NC | D15 | SW11_P | E15 | NC | - | - |
| A16 | SW12_A | B16 | NC | C16 | SW12_P | D16 | NC | E16 | NC | - | -- |
| A17 | NC | B17 | SW13_A | C17 | NC | D17 | SW13_P | E17 | NC | -- | - |
| A18 | SW14_A | B18 | NC | C18 | SW14_P | D18 | NC | E18 | SW16_P | F18 | NC |
| A19 | NC | B19 | SW15_A | C19 | NC | D19 | SW15_P | E19 | NC | F19 | SW18_P |
| A20 | VLL | B20 | NC | C20 | RGND | D20 | NC | E20 | SW17_P | F20 | NC |
| A21 | GND | B21 | THP | C21 | GND | D21 | SW16_A | E21 | NC | F21 | SW18_A |
| A22 | DOUT | B22 | CLKOUT | C22 | VDD | D22 | NC | E22 | SW17_A | F22 | NC |


| No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| G1 | NC | H1 | SW59_A | J1 | NC | K1 | SW57_A | L1 | NC | M1 | SW55_A |
| G2 | SW60_A | H2 | NC | J2 | SW58_A | K2 | NC | L2 | SW56_A | M2 | NC |
| G3 | NC | H3 | SW59_P | J3 | NC | K3 | SW57_P | L3 | NC | M3 | SW55_P |
| G4 | SW60_P | H4 | NC | J4 | SW58_P | K4 | NC | L4 | SW56_P | M4 | NC |
| G5 | NC | H5 | NC | J5 | NC | K5 | NC | L5 | NC | M5 | NC |
| - | - | - | - | - | - | - | - | - | - | - | - |
| G7 | GND | H7 | GND | J7 | GND | K7 | GND | L7 | GND | M7 | GND |
| G8 | GND | H8 | GND | J8 | GND | K8 | GND | L8 | GND | M8 | GND |
| G9 | GND | H9 | GND | J9 | GND | K9 | GND | L9 | GND | M9 | GND |
| G10 | GND | H10 | GND | J10 | GND | K10 | GND | L10 | GND | M10 | GND |
| G11 | GND | H11 | GND | J11 | GND | K11 | GND | L11 | GND | M11 | GND |
| G12 | GND | H12 | GND | J12 | GND | K12 | GND | L12 | GND | M12 | GND |
| G13 | GND | H13 | GND | J13 | GND | K13 | GND | L13 | GND | M13 | GND |
| G14 | GND | H14 | GND | J14 | GND | K14 | GND | L14 | GND | M14 | GND |
| G15 | GND | H15 | GND | J15 | GND | K15 | GND | L15 | GND | M15 | GND |
| G16 | GND | H16 | GND | J16 | GND | K16 | GND | L16 | GND | M16 | GND |
| - | - | - | - | - | - | - | - | - | - | - | - |
| G18 | NC | H18 | NC | J18 | NC | K18 | NC | L18 | NC | M18 | NC |
| G19 | NC | H19 | SW20_P | J19 | NC | K19 | SW22_P | L19 | NC | M19 | SW24_P |
| G20 | SW19_P | H20 | NC | J20 | SW21_P | K20 | NC | L20 | SW23_P | M20 | NC |
| G21 | NC | H21 | SW20_A | J21 | NC | K21 | SW22_A | L21 | NC | M21 | SW24_A |
| G22 | SW19_A | H22 | NC | J22 | SW21_A | K22 | NC | L22 | SW23_A | M22 | NC |


| No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name | No. | Pin Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| N1 | NC | P1 | SW53_A | Q1 | NC | R1 | SW51_A | S1 | NC |
| N2 | SW54_A | P2 | NC | Q2 | SW52_A | R2 | NC | S2 | SW50_A |
| N3 | NC | P3 | SW53_P | Q3 | NC | R3 | SW51_P | S3 | NC |
| N4 | SW54_P | P4 | NC | Q4 | SW52_P | R4 | NC | S4 | SW50_P |
| N5 | NC | P5 | NC | Q5 | NC | R5 | NC | S5 | NC |
| - | - | - | - | - | - | - | - | - | - |
| N7 | GND | P7 | GND | Q7 | GND | R7 | GND | - | - |
| N8 | GND | P8 | GND | Q8 | GND | R8 | GND | - | - |
| N9 | GND | P9 | GND | Q9 | GND | R9 | GND | - | - |
| N10 | GND | P10 | GND | Q10 | GND | R10 | GND | - | - |
| N11 | GND | P11 | GND | Q11 | GND | R11 | GND | - | - |
| N12 | GND | P12 | GND | Q12 | GND | R12 | GND | - | - |
| N13 | GND | P13 | GND | Q13 | GND | R13 | GND | - | - |
| N14 | GND | P14 | GND | Q14 | GND | R14 | GND | - | - |
| N15 | GND | P15 | GND | Q15 | GND | R15 | GND | - | - |
| N16 | GND | P16 | GND | Q16 | GND | R16 | GND | - | - |
| - | - | - | - | - | - | - | - | - | - |
| N18 | NC | P18 | NC | Q18 | NC | R18 | NC | S18 | NC |
| N19 | NC | P19 | SW26_P | Q19 | NC | R19 | SW28_P | S19 | NC |
| N20 | SW25_P | P20 | NC | Q20 | SW27_P | R20 | NC | S20 | SW29_P |
| N21 | NC | P21 | SW26_A | Q21 | NC | R21 | SW28_A | S21 | NC |
| N22 | SW25_A | P22 | NC | Q22 | SW27_A | R22 | NC | S22 | SW29_A |


|  | A | B | c | D | E | F | G | H | J | K | L | M | N | P | Q | R | s | T | $u$ | v | w | x |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | DIN | CLKIN | VLL | sw63_A | NC | sw61_A | NC | SW59_A | NC | SW57_A | NC | SW55_A | NC | SW53_A | NC | SW51_A | NC | sw49_A | NC | vDD | BANK3 | bank2 |
| 2 | LEB | RESET | VDD | NC | SW62_A | NC | SW60_A | NC | SW58_A | NC | SW56_A | NC | SW54_A | NC | SW52_A | NC | SW50_A | NC | SW48_A | GND | CLR | CLKOUT_ <br> EN |
| 3 | GND | GND | RGND | SW63_P | NC | SW61_P | NC | SW59_P | NC | SW57_P | NC | SW55_P | nc | SW53_P | NC | SW51_P | nc | SW49_P | NC | R_ENB | RGND | GND |
| 4 | swo_A | NC | Swo_P | NC | SW62_P | NC | SW60_P | nc | SW58_P | NC | SW56_P | NC | SW54_P | NC | SW52_P | NC | SW50_P | nc | SW47_P | NC | SW47_A | nc |
| 5 | NC | sw1_A | NC | SW1_P | NC | NC | NC | nc | nc | NC | nc | NC | NC | nc | NC | nc | NC | SW48_P | NC | SW46_P | NC | SW46_A |
| 6 | SW2_A | NC | SW2_P | NC | NC | NC | - | - | - | - | - | - | - | - | - | - | - | NC | SW45_P | NC | SW45_A | NC |
| 7 | NC | SW3_A | NC | sw3_P | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | NC | SW44_P | NC | SW44_A |
| 8 | SW4_A | NC | SW4_P | NC | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | SW43_P | NC | SW43_A | NC |
| 9 | NC | sw5_A | NC | SW5_P | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | NC | SW42_P | NC | SW42_A |
| 10 | sw6_A | NC | SW6_P | NC | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | SW41_P | NC | SW41_A | NC |
| 11 | NC | sw7_A | NC | SW7_P | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | NC | SW40_P | NC | SW40_A |
| 12 | sw8_A | NC | Sw8_P | NC | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | sw39_P | NC | SW39_A | NC |
| 13 | NC | sw9_A | NC | sw9_p | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | NC | SW38_P | NC | SW38_A |
| 14 | sw10_A | NC | SW10_P | NC | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | SW37_P | NC | SW37_A | NC |
| 15 | NC | SW11_A | NC | SW11_P | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | NC | SW36_P | NC | sw36_A |
| 16 | sw12_A | NC | SW12_P | NC | NC | - | GND | GND | GND | GND | GND | GND | GND | GND | GND | GND | - | NC | SW35_P | NC | SW35_A | NC |
| 17 | NC | SW13_A | NC | SW13_P | NC | - | - | - | - | - | - | - | - | - | - | - | - | NC | NC | SW34_P | NC | SW34_A |
| 18 | sW14_A | NC | SW14_P | NC | SW16_P | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | NC | SW33_P | NC | SW33_A | NC |
| 19 | NC | SW15_A | NC | SW15_P | NC | SW18_P | NC | SW20_P | NC | SW22_P | NC | SW24_P | NC | SW26_P | NC | SW28_P | NC | SW30_P | NC | SW32_P | NC | SW32_A |
| 20 | VLL | NC | RGND | NC | SW17_P | NC | SW19_P | NC | SW21_P | NC | SW23_P | NC | SW25_P | NC | SW27_P | NC | SW29_P | NC | SW31_P | RGND | BANKo | NC |
| 21 | GND | THP | GND | sW16_A | NC | SW18_A | NC | SW20_A | NC | SW22_A | NC | SW24_A | NC | sw26_A | NC | sw28_A | NC | SW30_A | NC | GND | GND | bank1 |
| 22 | Dout | clkout | vDD | NC | SW17_A | nc | SW19_A | NC | sw21_A | NC | sw23_A | NC | sW25_A | NC | SW27_A | NC | sw29_A | NC | sw31_A | GND | vDD | BANK_EN |

## ■ Package

| Package Name | Dimension | Tray | Marking | Land | Packing |
| :---: | :---: | :---: | :---: | :---: | :---: |
| BGA-441(1515)A | RA441-A-P-S1 | RA441-A-T-SD | RA441-A-M-SD | RA441-A-L-SD | RA441-A-K-SD |

## Storage, Mounting

## 1. Storage conditions

1. 1 The storage location should be kept at 5 to $35^{\circ} \mathrm{C}$ and 40 to $70 \%$ relative humidity. Keeping in a dry box is recommended. Moisture-proof property is assured for 12 months from delivery date for sealed moisture-proof packing, while it is guaranteed for 7 days from unpacked date under the condition above.
2. 2 When the storage conditions do not conform to those above or other conditions occur indicating moisture exposure, the ICs should be dried to avoid package cracks. A baking process at $125^{\circ} \mathrm{C}$ lasting for 24 hours results in sufficient dehumidification. The baking is not allowed more than twice, and the ICs should be mounted within 7 days after initial baking or within 10 days of total exposure after the second dehumidification.

## 2. Reflow soldering

The temperature rise may be different in the resin and a terminal part due to the reflow soldering.
It is necessary to check the package surface temperature (resin) before setting the temperature profile.
Figure 1 shows the resistance to soldering heat condition for package (Reflow method).
Confirm the heat resistance of the package shown below. (Based on JEDEC J-STD-020).


Figure 1 Resistance to Soldering Heat Condition for Package (Reflow Method)

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## ■ Cautions

1. Customers are advised to follow the cautions below to protect products from damage caused by electrical static discharge (ESD).
2. 1 Material of container or any device to carry products should be free from ESD, which may be caused by vibration while transportation. It is recommended that electric-conductive container or aluminum sheet be used as an effective countermeasure.
3. 2 Those that touch products, such as work platform, machine, or measurement/test equipment, should be grounded.
4. 3 Those who deal with products should be grounded through a large series impedance around $100 \mathrm{k} \Omega$ to $1 \mathrm{M} \Omega$.
5. 4 Prevent friction with other materials made with high polymer.
6. 5 Prevent vibration or friction when carrying the printed circuit board (PCB) where products are mounted. To short circuit terminals is a recommended countermeasure to keep the same electric potential on the PCB.
7. 6 Avoid dealing with or storing products in an extremely arid environment.
8. "Absolute maximum ratings" should never be exceeded during use regardless of any change in external conditions. Otherwise, products may be damaged or destroyed. In no event shall ABLIC Inc. be liable for any failure in products or any secondary damage resulting from use at a value exceeding the absolute maximum ratings.
9. Products may experience failures due to accident or unexpected surge voltages. Accordingly, adopt safe design features, such as redundancy or prevention of erroneous action, to avoid extensive damage in the event of a failure. (If a semiconductor device fails, there may be cases in which the semiconductor device, wiring or wiring pattern will emit smoke or cause a fire or in which the semiconductor device will burst.)
10. Products may experience failures or malfunction in poor surroundings, such as electrical leakage in products due to long-term use in high humidity, malfunctioning or permanent damage due to chemical reaction of products in corrosive environment or due to discharge by strongly charged object near products or due to excessive mechanical shock. To use products in radiation environment is not assumed. To use products near material easy to ignite may cause a fire due to its flammable package. Avoid using products in such environment or take appropriate countermeasures depending on the environment.
11. Products are not designed, manufactured, or warranted to be suitable for use where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, life-support-related medical equipment, fuel control equipment and various kinds of safety equipment). Inclusion of products in such application shall be fully at the risk of customers. ABLIC Inc. assumes no liability for applications assistance, customer product design, or performance.


No. RA441-A-P-S1-1.0

| TITLE | BGA441-A-PKG Dimensions <br> (S-UM6532) |
| :---: | :---: |
| No. | RA441-A-P-S1-1.0 |
| ANGLE | ( |
| UNIT | mm |
|  |  |
|  |  |
| ABLIC Inc. |  |



No. RA441-A-T-SD-1.0

1\#Pin

| TITLE | BGA441-A-Tray |  |  |
| :---: | :---: | :---: | :---: |
| No. | RA441-A-T-SD-1.0 |  |  |
| ANGLE |  | QTY. |  |
| UNIT | mm |  |  |
|  |  |  |  |
|  |  |  |  |
| ABLIC Inc. |  |  |  |


(1) to (10) : Product code
(11), (12) : Quality control code
(13) : Year of assembly
(14) : Month of assembly
(15) : Week of assembly
(16) to (25) : Quality control code
(A) : 1-pin mark

No. RA441-A-M-SD-1.0

| TITLE | BGA441-A-Markings |  |  |
| :---: | :---: | :---: | :---: |
| No. | RA441-A-M-SD-1.0 |  |  |
| ANGLE |  |  |  |
| UNIT | TYPE |  |  |
|  | LASER |  |  |
|  | ABLIC Inc. |  |  |



No. RA441-A-L-SD-1.0

| TITLE | BGA441-A <br> -Land Recommendation |
| :---: | :---: |
| No. | RA441-A-L-SD-1.0 |
| ANGLE |  |
| UNIT | mm |
|  |  |
|  |  |
| ABLIC Inc. |  |



Humidity Indicator Card

Solid Desiccant

(Cardboard Paper)


No. RA441-A-K-SD-1.0

| TITLE | BGA441-A <br> -Packing Procedure |
| :---: | :---: |
| No. | RA441-A-K-SD-1.0 |
| ANGLE |  |
| UNIT |  |
|  |  |
|  |  |
| ABLIC Inc. |  |

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The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.
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